# Standard Frequency, High Temperature Oscillator



#### **Features**

- 33 standard frequencies between 7.3728 MHz and 48 MHz
- Supply voltage of 1.8V or 2.5V to 3.3V continuous
- Operating temperature from -40°C to 125°C. For -55°C option, refer to SiT8920 and SiT8921
- Excellent total frequency stability as low as ±20 ppm
- Low power consumption of 3.5 mA typical at 1.8V
- LVCMOS/LVTTL compatible output
- Industry-standard packages: 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mm x mm
- Instant samples with Time Machine II and field programmable oscillators
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free
- For AEC-Q100 oscillators, refer to SiT8924 and SiT8925

#### **Applications**

- Industrial, medical, automotive, avionics and other high temperature applications
- Industrial sensors, PLC, motor servo, outdoor networking equipment, medical video cam, asset tracking systems, etc.







## **Electrical Specifications**

#### **Table 1. Electrical Characteristics**

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at 25°C and nominal supply voltage.

| Parameters                  | Symbol | Min. | Тур.                         | Max.          | Unit         | Condition  |
|-----------------------------|--------|------|------------------------------|---------------|--------------|--|
|                             |        |      | F                            | requency R    | ange         |  |
| Output Frequency Range      | f      |      | rd frequencie<br>3 MHz and 4 |               | MHz          | Refer to Table 13 for the exact list of supported frequencies                                    |
|                             | 1      |      | Freque                       | ncy Stability | and Aging    |  |
| Frequency Stability         | F_stab | -20  | _                            | +20           | ppm          | Inclusive of Initial tolerance at 25°C, 1st year aging at 25°C, and                              |
|                             |        | -25  | -                            | +25           | ppm          | variations over operating temperature, rated power supply voltage and load.                      |
|                             |        | -30  | -                            | +30           | ppm          | - voltage and load.  |
|                             |        | -50  | -                            | +50           | ppm          |  |
|                             |        |      | Operati                      | ng Tempera    | ture Range   | 9  |
| Operating Temperature Range | T_use  | -40  | _                            | +105          | °C           | Extended Industrial  |
| (ambient)                   |        | -40  | _                            | +125          | °C           | Automotive   |
|                             |        | Sı   | ipply Voltag                 | ge and Curre  | ent Consur   | nption   |
| Supply Voltage              | Vdd    | 1.62 | 1.8                          | 1.98          | V            |  |
|                             |        | 2.25 | 2.5                          | 2.75          | <b>V</b>     |  |
|                             |        | 2.52 | 2.8                          | 3.08          | <b>V</b>     |  |
|                             |        | 2.7  | 3.0                          | 3.3           | <b>V</b>     |  |
|                             |        | 2.97 | 3.3                          | 3.63          | V            |  |
|                             |        | 2.25 | _                            | 3.63          | V            |  |
| Current Consumption         | Idd    | -    | 3.8                          | 4.7           | mA           | No load condition, f = 20 MHz, Vdd = 2.8V, 3.0V or 3.3V  |
|                             |        | -    | 3.6                          | 4.5           | mA           | No load condition, f = 20 MHz, Vdd = 2.5V  |
|                             |        | -    | 3.5                          | 4.5           | mA           | No load condition, f = 20 MHz, Vdd = 1.8V  |
| OE Disable Current          | I_od   | _    | _                            | 4.5           | mA           | Vdd = 2.5V to 3.3V, OE = Low, Output in high Z state.  |
|                             |        | -    | _                            | 4.3           | mA           | Vdd = 1.8V, OE = Low, Output in high Z state.  |
| Standby Current             | I_std  | -    | 2.6                          | 8.5           | μΑ           | Vdd = $2.8V$ to $3.3V$ , $\overline{ST}$ = Low, Output is weakly pulled down                     |
|                             |        | -    | 1.4                          | 5.5           | μΑ           | Vdd = 2.5V, ST = Low, Output is weakly pulled down   |
|                             |        | -    | 0.6                          | 4.0           | μΑ           | Vdd = 1.8V, $\overline{ST}$ = Low, Output is weakly pulled down                                  |
|                             |        |      | LVCMOS                       | Output Cha    | aracteristic | es   |
| Duty Cycle                  | DC     | 45   | -                            | 55            | %            | All Vdds   |
| Rise/Fall Time              | Tr, Tf | _    | 1.0                          | 2.0           | ns           | Vdd = 2.5V, 2.8V, 3.0V or 3.3V, 20% - 80%  |
|                             |        | _    | 1.3                          | 2.5           | ns           | Vdd =1.8V, 20% - 80%   |
|                             |        | -    | 1.0                          | 3             | ns           | Vdd = 2.25V - 3.63V, 20% - 80%   |
| Output High Voltage         | VOH    | 90%  | _                            | _             | Vdd          | IOH = -4 mA (Vdd = 3.0V or 3.3V)<br>IOH = -3 mA (Vdd = 2.8V or 2.5V)<br>IOH = -2 mA (Vdd = 1.8V) |
| Output Low Voltage          | VOL    | -    | -                            | 10%           | Vdd          | IOL = 4 mA (Vdd = 3.0V or 3.3V)<br>IOL = 3 mA (Vdd = 2.8V or 2.5V)<br>IOL = 2 mA (Vdd = 1.8V)    |

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## **Table 1. Electrical Characteristics (continued)**

| Parameters                 | Symbol   | Min. | Тур.   | Max.        | Unit      | Condition  |  |  |  |
|----------------------------|----------|------|--------|-------------|-----------|--|--|--|--|
|                            |          |      | Inp    | ut Characte | ristics   |  |  |  |  |
| Input High Voltage         | VIH      | 70%  | -      | -           | Vdd       | Pin 1, OE or ST  |  |  |  |
| Input Low Voltage          | VIL      | -    | -      | 30%         | Vdd       | Pin 1, OE or ST  |  |  |  |
| Input Pull-up Impedance    | Z_in     | 50   | 87     | 150         | kΩ        | Pin 1, OE logic high or logic low, or ST logic high                  |  |  |  |
|                            |          | 2    | _      | _           | MΩ        | Pin 1, ST logic low  |  |  |  |
|                            |          |      | Startu | and Resu    | me Timing |  |  |  |  |
| Startup Time               | T_start  | _    | -      | 5           | ms        | Measured from the time Vdd reaches its rated minimum value           |  |  |  |
| Enable/Disable Time        | T_oe     | -    | -      | 162         | ns        | f = 48 MHz. For other frequencies, T_oe = 100 ns + 3 * clock periods |  |  |  |
| Resume Time                | T_resume | -    | _      | 5           | ms        | Measured from the time ST pin crosses 50% threshold                  |  |  |  |
|                            |          |      |        | Jitter      |           |  |  |  |  |
| RMS Period Jitter          | T_jitt   | -    | 1.6    | 2.5         | ps        | f = 20 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V                           |  |  |  |
|                            |          | _    | 1.9    | 4           | ps        | f = 20 MHz, Vdd = 1.8V   |  |  |  |
| Peak-to-peak Period Jitter | T_pk     | -    | 12     | 20          | ps        | f = 20 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V                           |  |  |  |
|                            |          | -    | 14     | 30          | ps        | f = 20 MHz, Vdd = 1.8V   |  |  |  |
| RMS Phase Jitter (random)  | T_phj    | -    | 0.5    | 0.8         | ps        | f = 40 MHz, Integration bandwidth = 900 kHz to 7.5 MHz               |  |  |  |
|                            |          | _    | 1.3    | 2           | ps        | f = 40 MHz, Integration bandwidth = 12 kHz to 20 MHz                 |  |  |  |

## **Table 2. Pin Description**

| Pin | Symbol    | Functionality    |  |  |  |  |  |
|-----|-----------|------------------|--|--|--|--|--|
|     |           | Output<br>Enable | H <sup>[1]</sup> : specified frequency output<br>L: output is high impedance. Only output driver is disabled.                                |  |  |  |  |
| 1   | OE/ ST/NC | Standby          | H <sup>[1]</sup> : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I_std. |  |  |  |  |
|     | No C      |                  | Any voltage between 0 and Vdd or Open <sup>[1]</sup> : Specified frequency output. Pin 1 has no function.                                    |  |  |  |  |
| 2   | GND       | Power            | Electrical ground  |  |  |  |  |
| 3   | OUT       | Output           | Oscillator output  |  |  |  |  |
| 4   | VDD       | Power            | Power supply voltage <sup>[2]</sup>  |  |  |  |  |

# Top View OE/ST/NC 1 4 VDD GND 2 3 OUT

Figure 1. Pin Assignments

#### Notes

- 1. In OE or  $\overline{ST}$  mode, a pull-up resistor of 10 k $\Omega$  or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- 2. A capacitor of value 0.1  $\mu F$  or higher between Vdd and GND is required.

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#### **Table 3. Absolute Maximum Limits**

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter  | Min. | Max. | Unit |
|--|------|------|------|
| Storage Temperature  | -65  | 150  | °C   |
| Vdd  | -0.5 | 4    | V    |
| Electrostatic Discharge  | -    | 2000 | V    |
| Soldering Temperature (follow standard Pb free soldering guidelines) | -    | 260  | °C   |
| Junction Temperature <sup>[3]</sup>                                  | _    | 150  | °C   |

#### Note:

## Table 4. Thermal Consideration<sup>[4]</sup>

| Package | θJA, 4 Layer Board<br>(°C/W) | θJA, 2 Layer Board<br>(°C/W) | θJC, Bottom<br>(°C/W) |
|---------|------------------------------|------------------------------|-----------------------|
| 7050    | 142                          | 273                          | 30                    |
| 5032    | 97                           | 199                          | 24                    |
| 3225    | 109                          | 212                          | 27                    |
| 2520    | 117                          | 222                          | 26                    |
| 2016    | 152                          | 252                          | 36                    |

#### Note:

## Table 5. Maximum Operating Junction Temperature<sup>[5]</sup>

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature |
|-------------------------------------|--|
| 105°C                               | 115°C                                  |
| 125°C                               | 135°C                                  |

#### Note

#### **Table 6. Environmental Compliance**

| Parameter                  | Condition/Test Method     |
|----------------------------|---------------------------|
| Mechanical Shock           | MIL-STD-883F, Method 2002 |
| Mechanical Vibration       | MIL-STD-883F, Method 2007 |
| Temperature Cycle          | JESD22, Method A104       |
| Solderability              | MIL-STD-883F, Method 2003 |
| Moisture Sensitivity Level | MSL1 @ 260°C              |

<sup>3.</sup> Exceeding this temperature for extended period of time may damage the device.

<sup>4.</sup> Refer to JESD51 for θJA and θJC definitions, and reference layout used to determine the θJA and θJC values in the above table.

<sup>5.</sup> Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

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#### Test Circuit and Waveform<sup>[6]</sup>

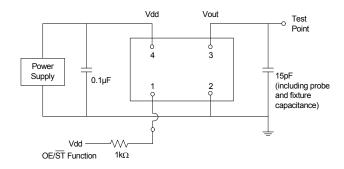


Figure 2. Test Circuit

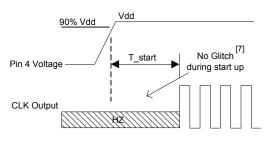
#### Note:

6. Duty Cycle is computed as Duty Cycle = TH/Period.

# tr — tf 80% Vdd 50% 20% Vdd High Pulse (TH) Period Period

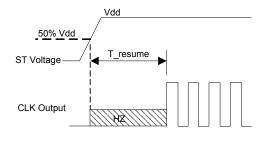
Figure 3. Waveform

## **Timing Diagrams**



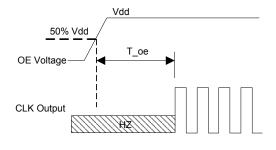
T\_start: Time to start from power-off

Figure 4. Startup Timing (OE/ST Mode)



T\_resume: Time to resume from ST

Figure 5. Standby Resume Timing (ST Mode Only)

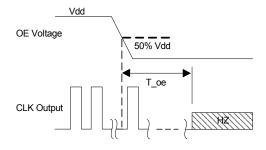


T\_oe: Time to re-enable the clock output

Figure 6. OE Enable Timing (OE Mode Only)

#### Note

7. SiT1618 has "no runt" pulses and "no glitch" output during startup or resume.



T\_oe: Time to put the output in High Z mode

Figure 7. OE Disable Timing (OE Mode Only)

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#### Performance Plots<sup>[8]</sup>

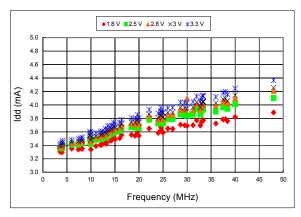


Figure 8. Idd vs Frequency

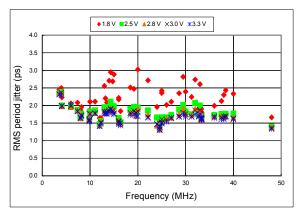


Figure 10. RMS Period Jitter vs Frequency

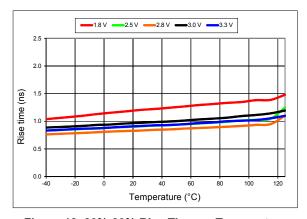


Figure 12. 20%-80% Rise Time vs Temperature

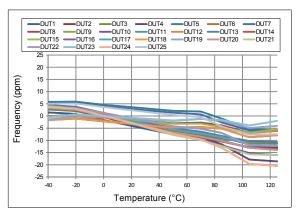


Figure 9. Frequency vs Temperature

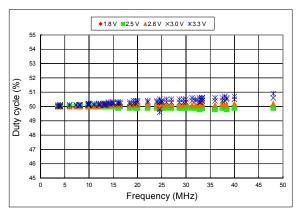


Figure 11. Duty Cycle vs Frequency

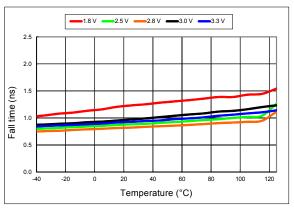
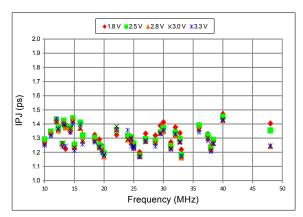


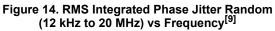
Figure 13. 20%-80% Fall Time vs Temperature

# Standard Frequency, High Temperature Oscillator



## Performance Plots<sup>[8]</sup>





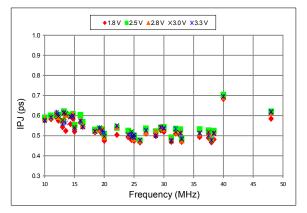


Figure 15. RMS Integrated Phase Jitter Random (900 kHz to 20 MHz) vs Frequency<sup>[9]</sup>

#### Notes:

- 8. All plots are measured with 15 pF load at room temperature, unless otherwise stated.
- 9. Phase noise plots are measured with Agilent E5052B signal source analyzer. Integration range is up to 5 MHz for carrier frequencies below 40 MHz.

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#### **Programmable Drive Strength**

The SiT1618 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, see the SiTime Application Notes section: http://www.sitime.com/support/application-notes.

#### **EMI Reduction by Slowing Rise/Fall Time**

Figure 16 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

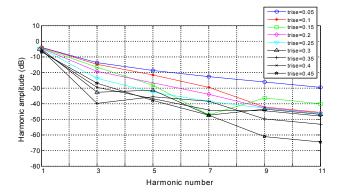


Figure 16. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

#### Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to speed up the rise/fall time of the input clock. Some chipsets may also require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the Rise/Fall Time Tables (Table 7 to Table 11) to determine the proper drive strength.

#### **High Output Load Capability**

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3V SiT1618 device with default drive strength setting, the typical rise/fall time is 1ns for 15 pF output load. The typical rise/fall time slows down to 2.6 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.83 ns by then increasing the drive strength setting on the SiT1618.

The SiT1618 can support up to 60 pF or higher in maximum capacitive loads with drive strength settings. Refer to the Rise/Tall Time Tables (Table 7 to 11) to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

#### SiT1618 Drive Strength Selection

Tables 7 through 11 define the rise/fall time for a given capacitive load and supply voltage.

- 1. Select the table that matches the SiT1618 nominal supply voltage (1.8V, 2.5V, 2.8V, 3.0V, 3.3V).
- 2. Select the capacitive load column that matches the application requirement (5 pF to 60 pF)
- 3. Under the capacitive load column, select the desired rise/fall times.
- 4. The left-most column represents the part number code for the corresponding drive strength.
- 5. Add the drive strength code to the part number for ordering purposes.

#### **Calculating Maximum Frequency**

Based on the rise and fall time data given in Tables 7 through 11, the maximum frequency the oscillator can operate with guaranteed full swing of the output voltage over temperature can be calculated:

Max Frequency = 
$$\frac{1}{5 \times Trf \ 20/80}$$

where Trf\_20/80 is the typical value for 20%-80% rise/fall time.

#### Example 1

Calculate f<sub>MAX</sub> for the following condition:

- Vdd = 1.8V (Table 7)
- · Capacitive Load: 30 pF
- Desired Tr/f time = 3 ns (rise/fall time part number code = E)

 $f_{\text{MAX}}$  = 48.000000 where 48 MHz is highest available frequency for this device.

Part number for the above example:

SiT1618BIE12-18E-48.000000



Drive strength code is inserted here. Default setting is "-"

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Rise/Fall Time (20% to 80%) vs  $C_{LOAD}$  Tables

Table 7. Vdd = 1.8V Rise/Fall Times for Specific  $C_{LOAD}$ 

| Rise/Fall Time Typ (ns)     |   |       |       |       |       |  |  |  |  |
|-----------------------------|---|-------|-------|-------|-------|--|--|--|--|
| Drive Strength \ $C_{LOAD}$ | Drive Strength \ C <sub>LOAD</sub> 5 pF 15 pF 30 pF 45 pF 60 pF |       |       |       |       |  |  |  |  |
| L                           | 6.16  | 11.61 | 22.00 | 31.27 | 39.91 |  |  |  |  |
| Α                           | 3.19  | 6.35  | 11.00 | 16.01 | 21.52 |  |  |  |  |
| R                           | 2.11  | 4.31  | 7.65  | 10.77 | 14.47 |  |  |  |  |
| В                           | 1.65  | 3.23  | 5.79  | 8.18  | 11.08 |  |  |  |  |
| Т                           | 0.93  | 1.91  | 3.32  | 4.66  | 6.48  |  |  |  |  |
| E                           | 0.78  | 1.66  | 2.94  | 4.09  | 5.74  |  |  |  |  |
| U                           | 0.70  | 1.48  | 2.64  | 3.68  | 5.09  |  |  |  |  |
| F or "-": default           | 0.65  | 1.30  | 2.40  | 3.35  | 4.56  |  |  |  |  |

Table 9. Vdd = 2.8V Rise/Fall Times for Specific  $C_{LOAD}$ 

| Rise/Fall Time Typ (ns)   |      |      |       |       |       |  |  |  |
|---|------|------|-------|-------|-------|--|--|--|
| Drive Strength \ C <sub>LOAD</sub> 5 pF 15 pF 30 pF 45 pF 60 pF |      |      |       |       |       |  |  |  |
| L   | 3.77 | 7.54 | 12.28 | 19.57 | 25.27 |  |  |  |
| Α   | 1.94 | 3.90 | 7.03  | 10.24 | 13.34 |  |  |  |
| R   | 1.29 | 2.57 | 4.72  | 7.01  | 9.06  |  |  |  |
| В   | 0.97 | 2.00 | 3.54  | 5.43  | 6.93  |  |  |  |
| Т   | 0.55 | 1.12 | 2.08  | 3.22  | 4.08  |  |  |  |
| E or "-": default   | 0.44 | 1.00 | 1.83  | 2.82  | 3.67  |  |  |  |
| U   | 0.34 | 0.88 | 1.64  | 2.52  | 3.30  |  |  |  |
| F   | 0.29 | 0.81 | 1.48  | 2.29  | 2.99  |  |  |  |

Table 11. Vdd = 3.3V Rise/Fall Times for Specific  $C_{LOAD}$ 

|                                    | Rise/Fall Time Typ (ns) |       |       |       |       |  |  |
|------------------------------------|-------------------------|-------|-------|-------|-------|--|--|
| Drive Strength \ C <sub>LOAD</sub> | 5 pF                    | 15 pF | 30 pF | 45 pF | 60 pF |  |  |
| L                                  | 3.39                    | 6.88  | 11.63 | 17.56 | 23.59 |  |  |
| Α                                  | 1.74                    | 3.50  | 6.38  | 8.98  | 12.19 |  |  |
| R                                  | 1.16                    | 2.33  | 4.29  | 6.04  | 8.34  |  |  |
| В                                  | 0.81                    | 1.82  | 3.22  | 4.52  | 6.33  |  |  |
| T or "-": default                  | 0.46                    | 1.00  | 1.86  | 2.60  | 3.84  |  |  |
| E                                  | 0.33                    | 0.87  | 1.64  | 2.30  | 3.35  |  |  |
| U                                  | 0.28                    | 0.79  | 1.46  | 2.05  | 2.93  |  |  |
| F                                  | 0.25                    | 0.72  | 1.31  | 1.83  | 2.61  |  |  |

Table 8. Vdd = 2.5V Rise/Fall Times for Specific C<sub>LOAD</sub>

| Rise/Fall Time Typ (ns)            |   |      |       |       |       |  |  |  |
|------------------------------------|---|------|-------|-------|-------|--|--|--|
| Drive Strength \ C <sub>LOAD</sub> | Drive Strength \ C <sub>LOAD</sub> 5 pF 15 pF 30 pF 45 pF 60 pF |      |       |       |       |  |  |  |
| L                                  | 4.13  | 8.25 | 12.82 | 21.45 | 27.79 |  |  |  |
| Α                                  | 2.11  | 4.27 | 7.64  | 11.20 | 14.49 |  |  |  |
| R                                  | 1.45  | 2.81 | 5.16  | 7.65  | 9.88  |  |  |  |
| В                                  | 1.09  | 2.20 | 3.88  | 5.86  | 7.57  |  |  |  |
| T                                  | 0.62  | 1.28 | 2.27  | 3.51  | 4.45  |  |  |  |
| E or "-": default                  | 0.54  | 1.00 | 2.01  | 3.10  | 4.01  |  |  |  |
| U                                  | 0.43  | 0.96 | 1.81  | 2.79  | 3.65  |  |  |  |
| F                                  | 0.34  | 0.88 | 1.64  | 2.54  | 3.32  |  |  |  |

Table 10. Vdd = 3.0V Rise/Fall Times for Specific  $C_{LOAD}$ 

| Rise/Fall Time Typ (ns)            |      |       |       |       |       |  |  |  |
|------------------------------------|------|-------|-------|-------|-------|--|--|--|
| Drive Strength \ C <sub>LOAD</sub> | 5 pF | 15 pF | 30 pF | 45 pF | 60 pF |  |  |  |
| L                                  | 3.60 | 7.21  | 11.97 | 18.74 | 24.30 |  |  |  |
| Α                                  | 1.84 | 3.71  | 6.72  | 9.86  | 12.68 |  |  |  |
| R                                  | 1.22 | 2.46  | 4.54  | 6.76  | 8.62  |  |  |  |
| В                                  | 0.89 | 1.92  | 3.39  | 5.20  | 6.64  |  |  |  |
| T or "-": default                  | 0.51 | 1.00  | 1.97  | 3.07  | 3.90  |  |  |  |
| E                                  | 0.38 | 0.92  | 1.72  | 2.71  | 3.51  |  |  |  |
| U                                  | 0.30 | 0.83  | 1.55  | 2.40  | 3.13  |  |  |  |
| F                                  | 0.27 | 0.76  | 1.39  | 2.16  | 2.85  |  |  |  |

## Standard Frequency, High Temperature Oscillator



## Pin 1 Configuration Options (OE, ST, or NC)

Pin 1 of the SiT1618 can be factory-programmed to support three modes: Output Enable (OE), standby  $(\overline{ST})$  or No Connect (NC). These modes can also be programmed with the Time Machine using field programmable devices.

#### Output Enable (OE) Mode

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is typically enabled in <1 $\mu s$ .

## Standby (ST) Mode

In the  $\overline{ST}$  mode, a device enters into the standby mode when Pin 1 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few  $\mu A$ . When  $\overline{ST}$  is pulled High, the device goes through the "resume" process, which can take up to 5 ms.

#### No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and outputs the specified frequency regardless of the logic level on pin 1.

Table 12 below summarizes the key relevant parameters in the operation of the device in OE. ST. or NC mode.

Table 12. OE vs. ST vs. NC

|   | OE     | ST                | NC     |
|---|--------|-------------------|--------|
| Active current 20 MHz (max, 1.8V)             | 4.5 mA | 4.5 mA            | 4.5 mA |
| OE disable current (max. 1.8V)                | 4.3 mA | N/A               | N/A    |
| Standby current (typical 1.8V)                | N/A    | 0.6 uA            | N/A    |
| OE enable time at 48 MHz (max)                | 162 ns | N/A               | N/A    |
| Resume time from standby (max, all frequency) | N/A    | 5 ms              | N/A    |
| Output driver in OE disable/standby mode      | High Z | weak<br>pull-down | N/A    |

#### **Output on Startup and Resume**

The SiT1618 comes with gated output. Its clock output is accurate to the rated frequency stability within the first pulse from initial device startup or resume from the standby mode.

In addition, the SiT1618 features "no runt" pulses and "no glitch" output during startup or resume as shown in the waveform captures in Figure 17 and Figure 18.



Figure 17. Startup Waveform vs. Vdd

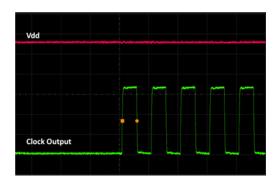


Figure 18. Startup Waveform vs. Vdd (Zoomed-in View of Figure 17)

# Instant Samples with Time Machine and Field Programmable Oscillators

SiTime supports a field programmable version of the <u>SiT1618 standard frequency</u>, <u>high temperature oscillator</u> for fast prototyping and real time customization of features. The <u>field programmable devices</u> (FP devices) are available for all five standard SiT1618 package sizes and can be configured to one's exact specification using the <u>Time Machine II</u>, an USB powered MEMS oscillator programmer.

#### Customizable Features of the SiT1618 FP Devices Include

- 33 standard frequencies between 7.3728 MHz and 48 MHz (Refer to the frequency list on page 12)
- Four frequency stability options, ±20 ppm, ±25 ppm, ±30 ppm, ±50 ppm
- Two operating temperatures, -40 to 105°C or -40 to 125°C
- Six supply voltage options, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V and 2.25 to 3.63V continuous
- · Output drive strength

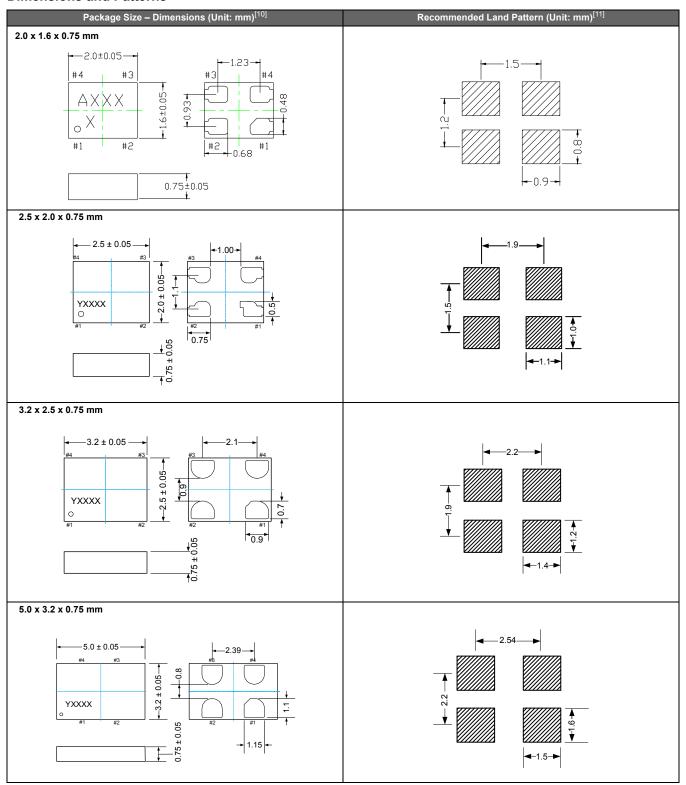
For more information regarding SiTime's field programmable solutions, visit <a href="http://www.sitime.com/time-machine">http://www.sitime.com/time-machine</a> and <a href="http://www.sitime.com/fp-devices">http://www.sitime.com/fp-devices</a>.

SiT1618 is factory-programmed per customer ordering codes for volume delivery.

# Standard Frequency, High Temperature Oscillator



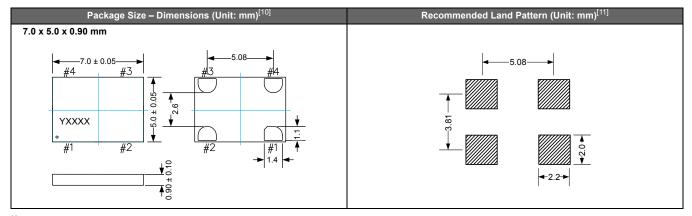
#### **Dimensions and Patterns**



# Standard Frequency, High Temperature Oscillator



#### **Dimensions and Patterns**



#### Notes:

- 10. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 11. A capacitor of value 0.1  $\mu F$  or higher between Vdd and GND is required.

# Standard Frequency, High Temperature Oscillator



### **Ordering Information**

The Part No. Guide is for reference only. To customize and build an exact part number, use the SiTime <u>Part Number</u> <u>Generator.</u>

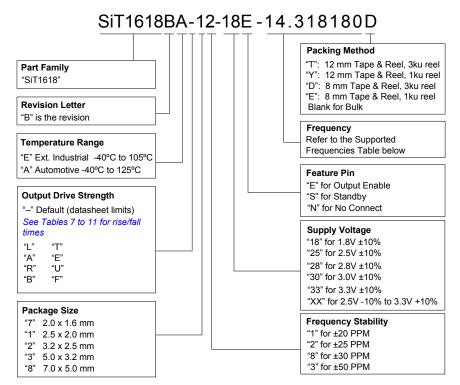


Table 13. List of Supported Frequencies

| 7.3728 MHz    | 8 MHz        | 8.192 MHz    | 9.8304 MHz  | 9.84375 MHz | 11.0592 MHz | 12 MHz     | 12.288 MHz | 13 MHz      |
|---------------|--------------|--------------|-------------|-------------|-------------|------------|------------|-------------|
| 13.225625 MHz | 13.52127 MHz | 14.31818 MHz | 14.7456 MHz | 15 MHz      | 16 MHz      | 16.384 MHz | 18.432 MHz | 19.6608 MHz |
| 20 MHz        | 22.1184 MHz  | 24 MHz       | 24.56 MHz   | 24.576 MHz  | 25 MHz      | 26 MHz     | 27 MHz     | 29.4912 MHz |
| 30 MHz        | 32 MHz       | 33 MHz       | 36 MHz      | 40 MHz      | 48 MHz      |            |            |             |

Table 14. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size<br>(mm x mm) | 16 mm T&R (3ku) | 16 mm T&R (1ku) | 12 mm T&R (3ku) | 12 mm T&R (1ku) | 8 mm T&R (3ku) | 8 mm T&R (1ku) |
|--------------------------|-----------------|-----------------|-----------------|-----------------|----------------|----------------|
| 2.0 x 1.6                | _               | -               | -               | -               | D              | E              |
| 2.5 x 2.0                | -               | -               | -               | -               | D              | E              |
| 3.2 x 2.5                | -               | -               | -               | -               | D              | E              |
| 5.0 x 3.2                | -               | -               | Т               | Y               | -              | -              |
| 7.0 x 5.0                | Т               | Y               | _               | -               | -              | -              |

# Standard Frequency, High Temperature Oscillator



#### **Table 15. Additional Information**

| Document                             | Description   | Download Link  |
|--------------------------------------|---|--|
| Time Machine II                      | MEMS oscillator programmer  | http://www.sitime.com/support/time-machine-oscillator-programmer                                   |
| Field<br>Programmable<br>Oscillators | Devices that can be programmable in the field by Time Machine II  | http://www.sitime.com/products/field-programmable-oscillators                                      |
| Manufacturing<br>Notes               | Tape & Reel dimension, reflow profile and other manufacturing related info  | http://www.sitime.com/component/docman/doc_download/243-manufacturing-notes-for-sitime-oscillators |
| Qualification<br>Reports             | RoHS report, reliability reports, composition reports   | http://www.sitime.com/support/quality-and-reliability  |
| Performance<br>Reports               | Additional performance data<br>such as phase noise, current<br>consumption and jitter for<br>selected frequencies | http://www.sitime.com/support/performance-measurement-report                                       |
| Termination<br>Techniques            | Termination design recommendations  | http://www.sitime.com/support/application-notes  |
| Layout Techniques                    | Layout recommendations  | http://www.sitime.com/support/application-notes  |

#### **Revision History**

#### Table 16. Datasheet Version and Change Log

| Version | Release Date | Change Summary  |
|---------|--------------|---|
| 1.0     | 7/14/14      | First Production Release  |
| 1.01    | 5/7/15       | Revised the Timing Diagrams and Performance Plots     Revised 2016 package diagram    |
| 1.02    | 6/18/15      | Added 16 mm T&R information to Table 14     Revised 12 mm T&R information to Table 14 |

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# **Supplemental Information**

The Supplemental Information section is not part of the datasheet and is for informational purposes only.



# Silicon MEMS Outperforms Quartz

# Silicon MEMS Outperforms Quartz



#### **Best Reliability**

Silicon is inherently more reliable than quartz. Unlike quartz suppliers, SiTime has in-house MEMS and analog CMOS expertise, which allows SiTime to develop the most reliable products. Figure 1 shows a comparison with quartz technology.

#### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal™ process, which eliminates foreign particles and improves long term aging and reliability
- · World-class MEMS and CMOS design expertise

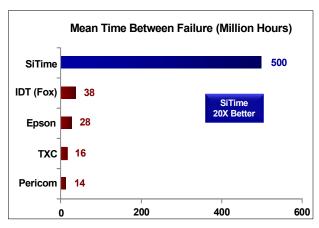


Figure 1. Reliability Comparison<sup>[1]</sup>

#### **Best Aging**

Unlike quartz, MEMS oscillators have excellent long term aging performance which is why every new SiTime product specifies 10-year aging. A comparison is shown in Figure 2.

#### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal process, which eliminates foreign particles and improves long term aging and reliability
- Inherently better immunity of electrostatically driven MEMS resonator

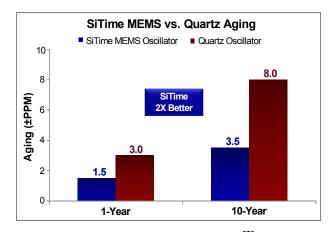


Figure 2. Aging Comparison<sup>[2]</sup>

#### Best Electro Magnetic Susceptibility (EMS)

SiTime's oscillators in plastic packages are up to 54 times more immune to external electromagnetic fields than quartz oscillators as shown in Figure 3.

#### Why is SiTime Best in Class:

- Internal differential architecture for best common mode noise rejection
- Electrostatically driven MEMS resonator is more immune to EMS

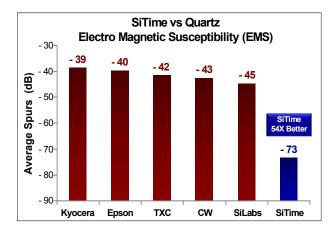


Figure 3. Electro Magnetic Susceptibility (EMS)<sup>[3]</sup>

#### **Best Power Supply Noise Rejection**

SiTime's MEMS oscillators are more resilient against noise on the power supply. A comparison is shown in Figure 4.

#### Why is SiTime Best in Class:

- On-chip regulators and internal differential architecture for common mode noise rejection
- · Best analog CMOS design expertise

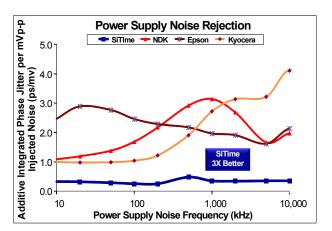


Figure 4. Power Supply Noise Rejection<sup>[4]</sup>

# Silicon MEMS Outperforms Quartz



#### **Best Vibration Robustness**

High-vibration environments are all around us. All electronics, from handheld devices to enterprise servers and storage systems are subject to vibration. Figure 5 shows a comparison of vibration robustness.

#### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

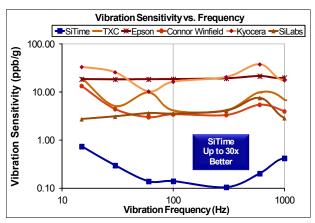


Figure 5. Vibration Robustness<sup>[5]</sup>

#### Notes:

- 1. Data Source: Reliability documents of named companies.
- 2. Data source: SiTime and quartz oscillator devices datasheets.
- 3. Test conditions for Electro Magnetic Susceptibility (EMS):
  - According to IEC EN61000-4.3 (Electromagnetic compatibility standard)
  - Field strength: 3V/m
  - Radiated signal modulation: AM 1 kHz at 80% depth
  - Carrier frequency scan: 80 MHz 1 GHz in 1% steps
  - · Antenna polarization: Vertical
  - DUT position: Center aligned to antenna

#### Devices used in this test:

SiTime, SiT9120AC-1D2-33E156.250000 - MEMS based - 156.25 MHz

Epson, EG-2102CA 156.2500M-PHPAL3 - SAW based - 156.25 MHz

TXC, BB-156.250MBE-T - 3rd Overtone guartz based - 156.25 MHz

Kyocera, KC7050T156.250P30E00 - SAW based - 156.25 MHz

Connor Winfield (CW), P123-156.25M - 3rd overtone quartz based - 156.25 MHz

SiLabs, Si590AB-BDG - 3rd overtone quartz based - 156.25 MHz

4. 50 mV pk-pk Sinusoidal voltage.

#### Devices used in this test:

SiTime, SiT8208AI-33-33E-25.000000, MEMS based - 25 MHz

NDK, NZ2523SB-25.6M - quartz based - 25.6 MHz

Kyocera, KC2016B25M0C1GE00 - quartz based - 25 MHz

Epson, SG-310SCF-25M0-MB3 - quartz based - 25 MHz

- 5. Devices used in this test: same as EMS test stated in Note 3.
- 6. Test conditions for shock test:
  - MIL-STD-883F Method 2002
  - Condition A: half sine wave shock pulse, 500-g, 1ms
  - $\bullet$  Continuous frequency measurement in 100  $\mu s$  gate time for 10 seconds

Devices used in this test: same as EMS test stated in Note 3

7. Additional data, including setup and detailed results, is available upon request to qualified customers. Please contact productsupport@sitime.com.

#### **Best Shock Robustness**

SiTime's oscillators can withstand at least  $50,000\ g$  shock. They all maintain their electrical performance in operation during shock events. A comparison with quartz devices is shown in Figure 6.

#### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

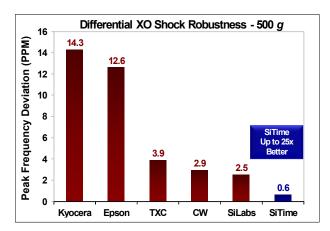


Figure 6. Shock Robustness<sup>[6]</sup>

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